IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

HANS-JUERGEN ENGELMANN EHRENFRIED ZSCHECH PETER HUEBLER

Serial No.: 10/813,223

Filed: March 30, 2004

FOR: METAL LINE HAVING AN INCREASED RESISTANCE TO ELECTROMIGRATION ALONG AN INTERFACE OF A DIELECTRIC BARRIER LAYER BY IMPLANTING MATERIAL INTO THE METAL LINE

Confirmation No.: 3854

Examiner: Leonardo Andujar

Group Art Unit: 2826

Att'y Docket: 2000.110900/DE0220

Customer No.: 23720

RESPONSE TO OFFICE ACTION DATED JUNE 15, 2006

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

This paper is submitted in response to the Office Action dated June 15, 2006, for which the three-month date for response is September 15, 2006.

No fees are believed to be due in connection with the present paper. However, should any fees be required under 37 C.F.R. §§ 1.16 to 1.21, the Director is authorized to deduct such fees from Williams, Morgan & Amerson, P.C. Deposit Account No. 50-0786/2000.110900.

Reconsideration of the application in view of the following amendments and remarks is respectfully requested.